IGBT - Field Stop, Trench 650 V, 75 A

FGHL75T65LQDTL4

Description

Field stop 4th generation Low V_{CE(sat)} IGBT technology and Full current rated copack Diode technology.

Features

- Maximum Junction Temperature: $T_I = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(Sat)} = 1.15 V (Typ.) @ I_C = 75 A
- 100% of the Part are Tested for I_{LM} (Note 2)
- Smooth & Optimized Switching
- Tight Parameter Distribution
- Co-Packed with Soft and Fast Recovery Diode
- RoHS Compliant

Typical Applications

- Solar Inverter
- UPS, ESS
- PFC, Converters

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector to Emitter Voltage	V _{CES}	650	V
Gate to Emitter Voltage Transient Gate to Emitter Voltage	V _{GES}	±20 ±30	V
Collector Current @ $T_C = 25^{\circ}C$ (Note 1)	۱ _C	80	А
Collector Current @ T _C = 100°C		75	
Pulsed Collector Current (Note 2)	I _{LM}	300	А
Pulsed Collector Current (Note 3)	I _{CM}	300	А
Diode Forward Current @ T _C = 25°C (Note 1)	١ _F	80	A
Diode Forward Current @ T _C = 100°C		75	
Pulsed Diode Maximum Forward Current	I _{FM}	300	А
Maximum Power Dissipation @ $T_C = 25^{\circ}C$	PD	469	W
Maximum Power Dissipation @ T_{C} = 100°C		234	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	–55 to +175	°C
Maximum Lead Temp. for Soldering Purposes (1/8" from case for 5 s)	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

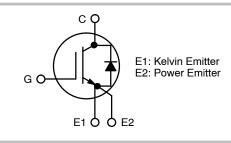
- 1. Value limit by bond wire.
- 2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, Inductive Load, 100% Tested.
- 3. Repetitive rating: Pulse width limited by max. Junction temperature.



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V _{CES}	lc	V _{CE(Sat)}
650 V	75 A	1.15 V





MARKING DIAGRAM



= ON Semiconductor Logo = Assembly Plant Code

- = 3-Digit Data Code
- = 2-Digit Lot Traceability Code

&K FGHL75T65LQDTL4 = Specific Device Code

\$Y

&Z

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ORDERING INFORMATION

Device	Package	Shipping
FGHL75T65LQDTL4	TO-247-4LD	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance Junction-to-Case, for IGBT	$R_{\theta JC}$	0.32	°C/W
Thermal Resistance Junction-to-Case, for Diode	$R_{\theta JC}$	0.48	°C/W
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

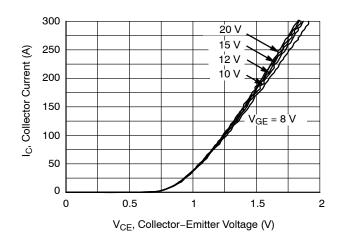
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•					
Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 1 mA	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\Delta BV_{CES} / \Delta T_J$	-	0.6	-	V/°C
Collector to Emitter Cut-off Current	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	-	-	250	μΑ
Gate Leakage Current	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	-	-	±400	nA
ON CHARACTERISTICS		• •				
Gate to Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 75 \text{ mA}$	V _{GE(th)}	3.0	4.5	6.0	V
Collector to Emitter Saturation Voltage		V _{CE(sat)}	-	1.15 1.22	1.35 -	V
DYNAMIC CHARACTERISTICS						
Input Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	C _{ies}	-	15030	-	pF
Output Capacitance		C _{oes}	-	181	-	
Reverse Transfer Capacitance		C _{res}	-	68	-	
Gate Charge Total	V_{CC} = 400 V, I_C = 75 V, V_{GE} = 15 V	Qg	-	779	-	nC
Gate to Emitter Charge		Q _{ge}	-	69	-	
Gate to Collector Charge	7	Q _{gc}	-	251	-	
SWITCHING CHARACTERISTICS, INDU	ICTIVE LOAD					
Turn-on Delay Time	$T_{J} = 25^{\circ}C,$	t _{d(on)}	-	40	-	ns
Rise Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 37.5 \text{ A},$ $R_{G} = 4.7 \Omega,$	t _r	-	12	-	
Turn-off Delay Time	V _{GE} = 15 V	t _{d(off)}	-	560	-	
Fall Time		t _f	-	144	-	
Turn-on Switching Loss		E _{on}	-	0.51	-	mJ
Turn-off Switching Loss		E _{off}	-	1.39	-]
Total Switching Loss		E _{ts}	-	1.9	-	
Turn-on Delay Time	$T_{J} = 25^{\circ}C,$	t _{d(on)}	-	40	-	ns
Rise Time	$V_{GC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A}, \\ R_{G} = 4.7 \Omega, \\ V_{GE} = 15 \text{ V}$	t _r	-	20	-	
Turn-off Delay Time		t _{d(off)}	-	548	-	
Fall Time		t _f	-	112	-	
Turn-on Switching Loss		E _{on}	-	1.01	-	mJ
Turn-off Switching Loss		E _{off}	-	2.53	-	
Total Switching Loss	7	E _{ts}	_	3.54	_	1

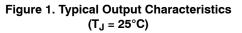
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS,	INDUCTIVE LOAD					
Turn-on Delay Time	$T_{\rm J} = 175^{\circ} \rm C,$	t _{d(on)}	-	32	-	ns
Rise Time	V_{CC} = 400 V, I _C = 37.5 A, R _G = 4.7 Ω,	t _r	-	16	-	
Turn-off Delay Time	V _{GE} = 15 V	t _{d(off)}	-	640	-	
Fall Time		t _f	-	212	-	
Turn-on Switching Loss		E _{on}	-	1.45	-	mJ
Turn-off Switching Loss		E _{off}	-	2	-	
Total Switching Loss		E _{ts}	-	3.45	-	1
Turn-on Delay Time	T _J = 175°C,	t _{d(on)}	-	36	-	ns
Rise Time	V_{CC} = 400 V, I _C = 75 A, R _G = 4.7 Ω,	tr	-	28	-	
Turn-off Delay Time	V _{GE} = 15 V	t _{d(off)}	-	616	-	1
Fall Time		t _f	-	168	-	
Turn-on Switching Loss		E _{on}	-	2.4	-	mJ
Turn-off Switching Loss		E _{off}	-	3.64	-	
Total Switching Loss		E _{ts}	-	6.04	-	
DIODE CHARACTERISTICS			-	4	•	
Diode Forward Voltage	I _F = 75 A, T _J = 25°C I _F = 75 A, T _J = 175°C	V _F		1.65 1.55	2.1 -	V
Reverse Recovery Energy	$T_J = 25^{\circ}C, V_R = 400 V,$	E _{REC}	-	105	-	μJ
Reverse Recovery Time	I _F = 37.5 A, di _F /dt = 1000 A/μs	T _{rr}	-	59	-	ns
Reverse Recovery Charge		Q _{rr}	-	574	-	nC
Reverse Recovery Current		I _{rr}	-	20	-	Α
Reverse Recovery Energy	$T_{J} = 25^{\circ}C, V_{R} = 400 V,$	E _{REC}	-	152	-	μJ
Reverse Recovery Time	I _F = 75 A, di _F /dt = 1000 A/μs	T _{rr}	-	87	-	ns
Reverse Recovery Charge		Q _{rr}	-	794	-	nC
Reverse Recovery Current		I _{rr}	-	18	-	Α
Reverse Recovery Energy	T _J = 175°C, V _R = 400 V,	E _{REC}	-	550	-	μJ
Reverse Recovery Time	I _F = 37.5 A, di _F /dt = 1000 A/μs	T _{rr}	-	119	-	ns
Reverse Recovery Charge		Q _{rr}	-	2154	-	nC
Reverse Recovery Current		I _{rr}	-	36	-	А
Reverse Recovery Energy	T _J = 175°C, V _R = 400 V,	E _{REC}	-	764	-	μJ
Reverse Recovery Time	I _F = 75 A, di _F /dt = 1000 A/μs	T _{rr}	-	145	-	ns
Reverse Recovery Charge		Q _{rr}	-	2947	_	nC
Reverse Recovery Current		I _{rr}	_	40	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





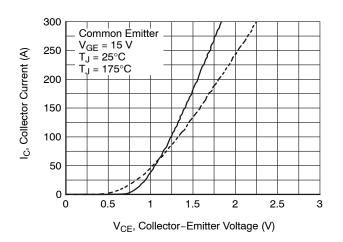


Figure 3. Typical Saturation Voltage Characteristics

150 A

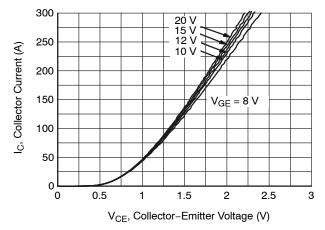
75 A

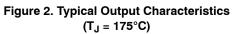
I_C = 37.5 A

100

150

200





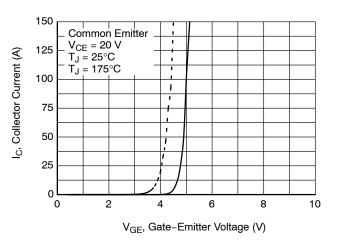
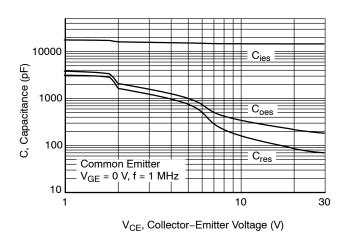
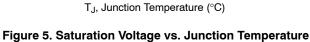


Figure 4. Typical Transfer Characteristics





50

 $V_{CE(Sat)},$ Collector-Emitter Saturation (V)

2.0

1.5

1.0

0.5

-100

-50

0

Common Émitter V_{GE} = 15 V

Figure 6. Capacitance Characteristics

TYPICAL CHARACTERISTICS (continued)

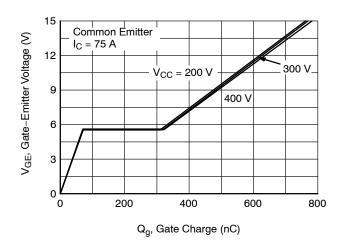
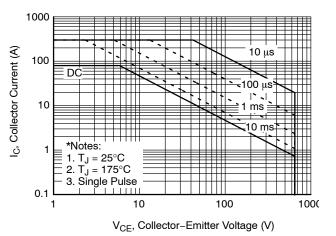


Figure 7. Gate Charge Characteristics





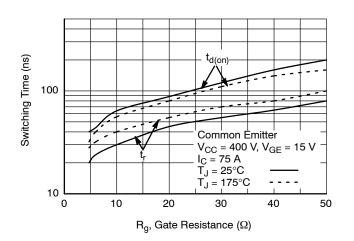
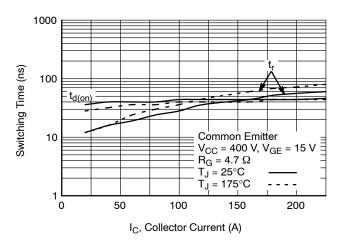
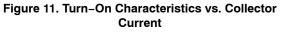


Figure 9. Turn-On Characteristics vs. Gate Resistance





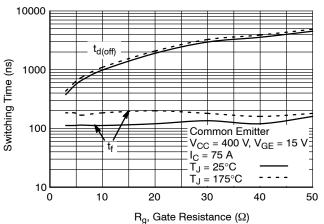
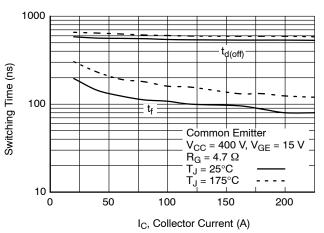
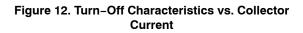
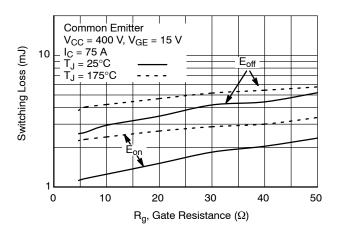


Figure 10. Turn–Off Characteristics vs. Gate Resistance





TYPICAL CHARACTERISTICS (continued)



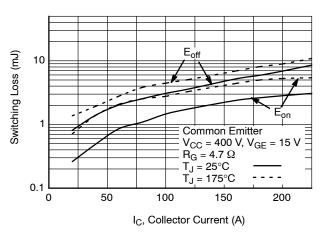


Figure 13. Switching Loss vs. Gate Resistance

Figure 14. Switching Loss vs. Collector Current

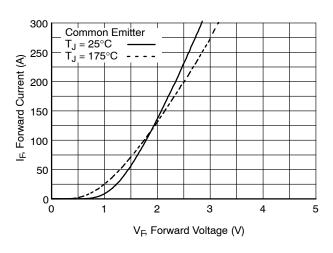


Figure 15. Forward Characteristics

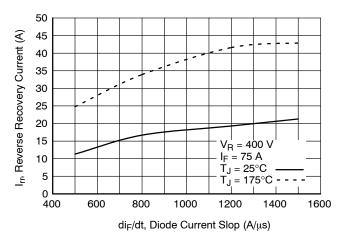


Figure 16. Reverse Recovery Current

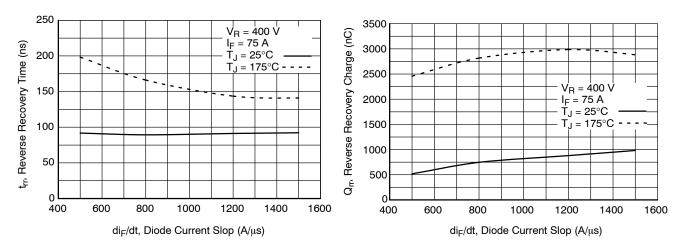
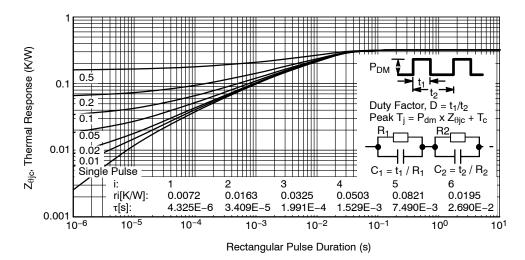


Figure 17. Reverse Recovery Time

Figure 18. Stored Charge

TYPICAL CHARACTERISTICS (continued)





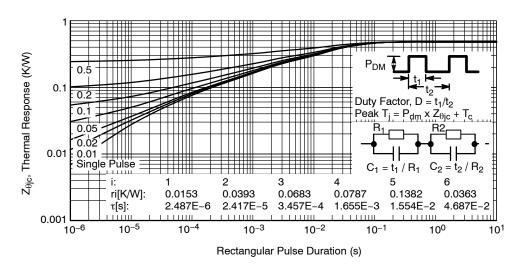


Figure 20. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

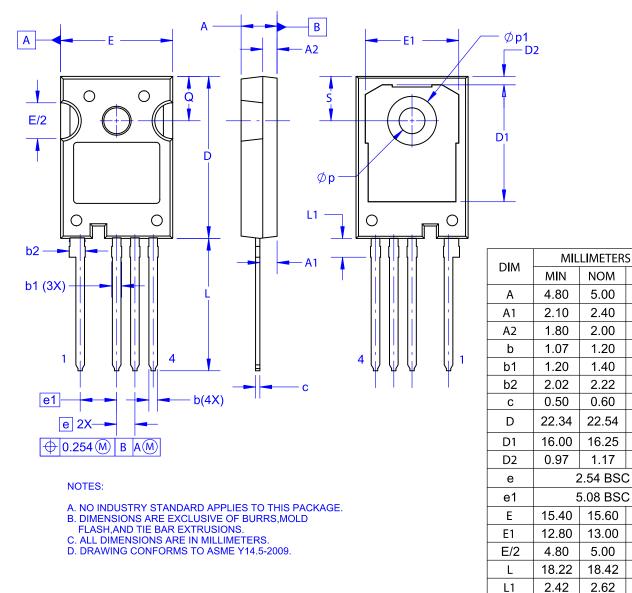
18.62

2.82

3.80

7.00 6.37

6.37



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